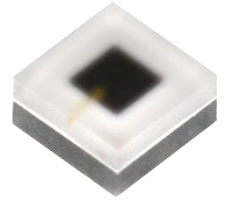


# HL1616F94CQ00 Datasheet



## Infrared Emitter

1616 Series (940nm) - 130°



### Applications

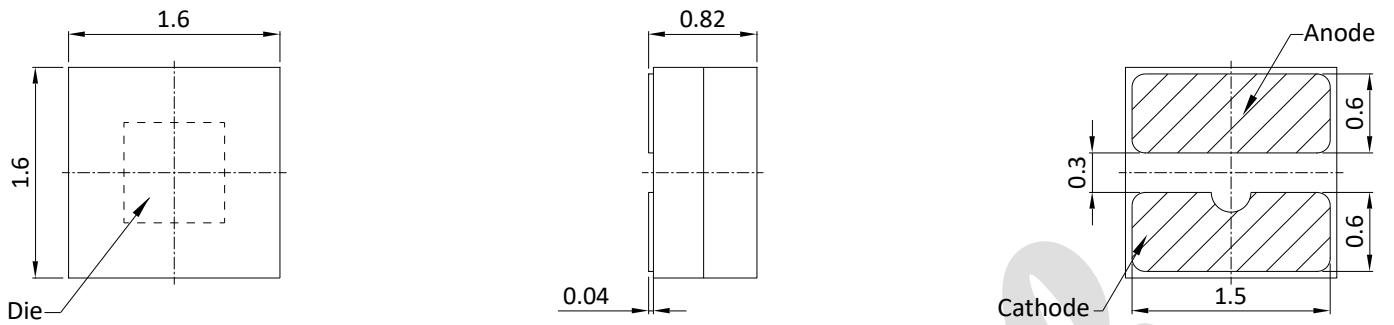
- Security System
- Automotive
- Facial Recognition
- Gesture Recognition

### Features

- Package: Clear silicone
- Low thermal resistance (Max. 12 K/W)
- Corrosion robustness class : A
- Peak wavelength 940 nm
- ESD: 2KV (HBM)
- Optimized for high current pulse operation
- IR light source with high efficiency
- RoHS 2.0 and REACH compliant
- Single junction emitter
- MSL 1 qualified according to J-STD 020
- Qualifications: AEC-Q102 Qualified

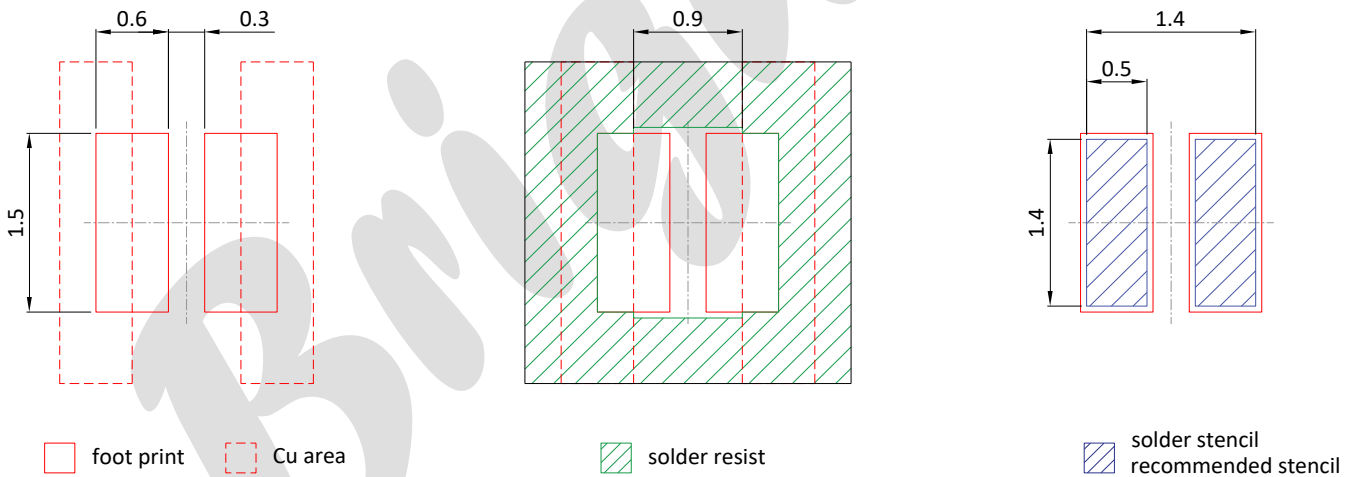
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## Dimensional Drawing



1. Dimensions are in millimeters.
2. General tolerance is  $\pm 0.05\text{mm}$ .
3. Lead finish Au.

## Recommended Solder Pad



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## Maximum Ratings

$T_A$  : 25 °C

Parameter	Symbol	Rating
Forward current	$I_F$	max. 1000 mA
Power consumption	$P_{tot}$	max. 2 W
Pulse forward current	$I_{PF}$	max. 2 A
Reverse voltage	$V_R$	max. 5 V
Junction temperature	$T_j$	max. 115 °C
Operating temperature	$T_{op}$	min. -40 °C
		max. 85 °C
Storage temperature	$T_{stg}$	min. -40 °C
		max. 85 °C
Soldering temperature	$T_{sol}$	max. 260 °C
Thermal resistance junction	$R_{th}$	typ. 9 K/W
		max. 12 K/W
ESD withstand voltage (HBM : MIL STD 883 Class 2)	$V_{ESD}$	max. 2 kV

1. For other ambient, limited setting of current will depend on de-rating curves.
2. When drive on maximum current, Junction temperature must be kept below 115°C.

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## Characteristics

$I_F$ : 1A |  $t_p$ : 10 ms |  $T_A$ : 25°C

Parameter	Symbol	Values
Peak wavelength	$\lambda_p$	typ. 940 nm
Spectral bandwidth	$\Delta\lambda$	typ. 55 nm
View angle	$2\theta_{1/2}$	typ. 130 °
Total radiant power	$\Phi_e$	min. 500 mW
		typ. 600 mW
		max. 700 mW
Radiant intensity	$I_E$	min. 150 mW/sr
		typ. 200 mW/sr
		max. 250 mW/sr
Forward voltage	$V_F$	min. 1.4 V
		typ. 1.75 V
		max. 2.0 V
Reverse current ( $V_R=5V$ )	$I_R$	max. 10 $\mu A$

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## Brightness Groups

Total radiant power  $I_F : 1A$  |  $t_p : 10$  ms

Group	min. $\Phi_e$	max. $\Phi_e$
PA5	500 mW	600 mW
PA6	600 mW	700 mW

Forward voltage  $I_F : 1A$  |  $t_p : 10$  ms

Group	min. $V_F$	max. $V_F$
CE	1.4 V	2.0 V

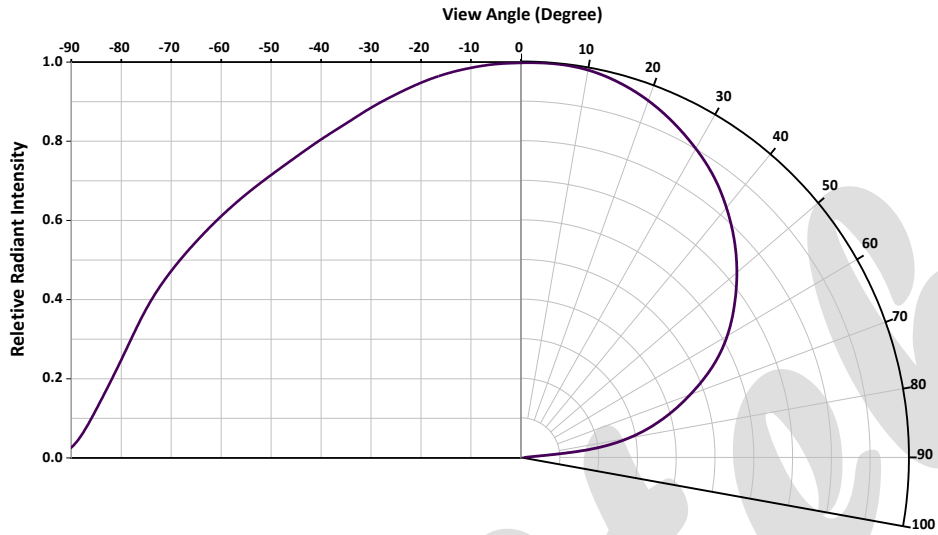
Peak wavelength  $I_F : 1A$  |  $t_p : 10$  ms

Group	min. $\lambda_p$	max. $\lambda_p$
F1	930 nm	950 nm

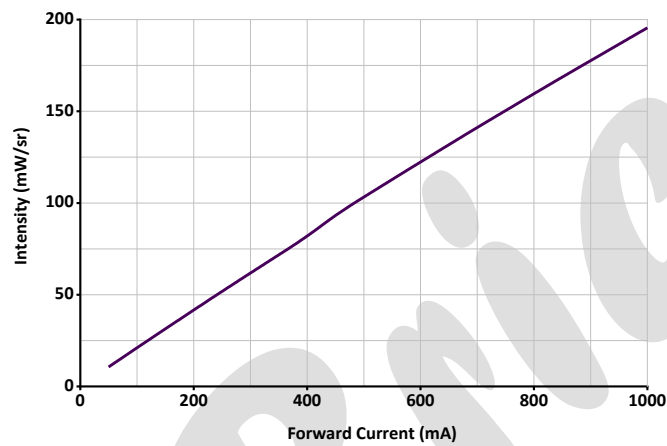
# HL1616F94CQ00

## Typical Electrical Optical Characteristics Curves

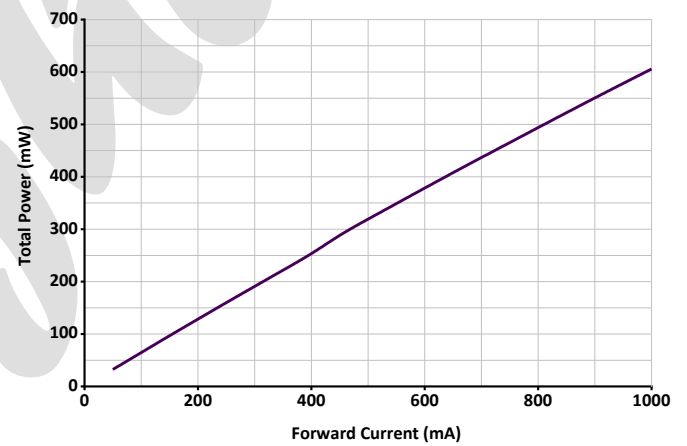
### Radiation Characteristics



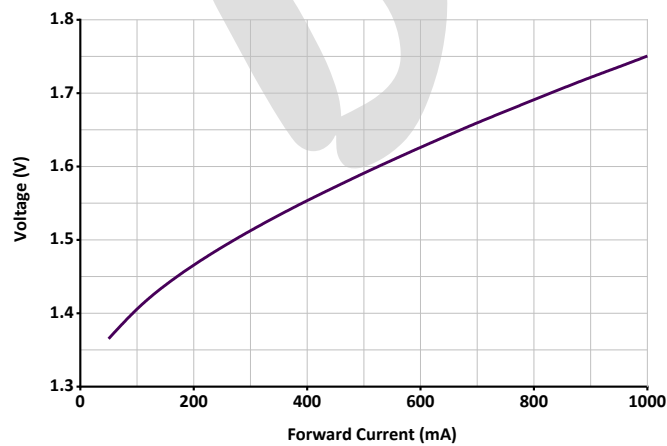
### Radiant Intensity



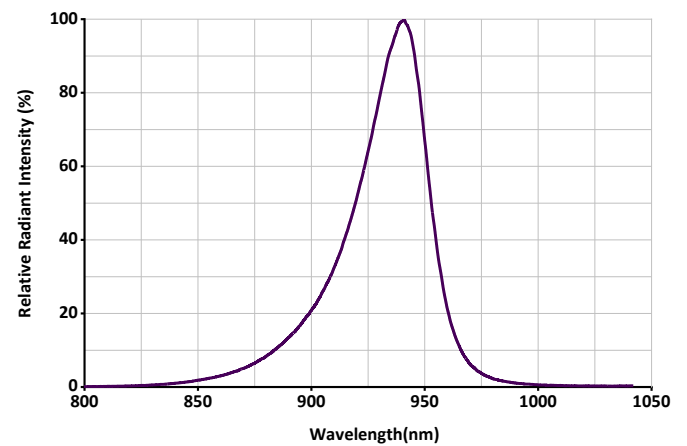
### Total radiant power



### Forward Voltage



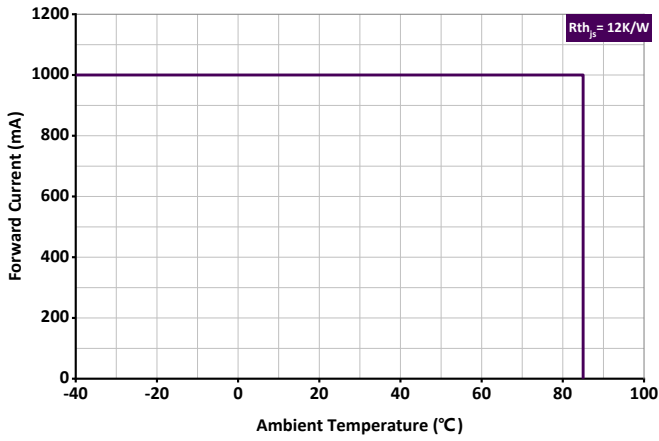
### Relative Spectral Emission



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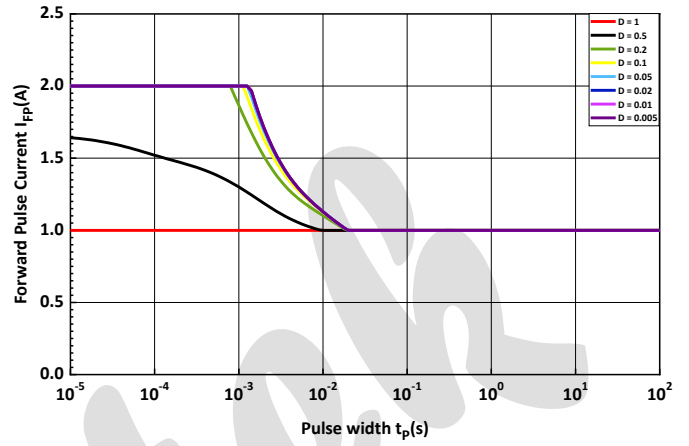
## Permissible Forward Current

$$I_{F,max} = f(T_s); R_{th_{j_s}} = 12 \text{ K/W}$$



## Permissible Pulse Handling Capability

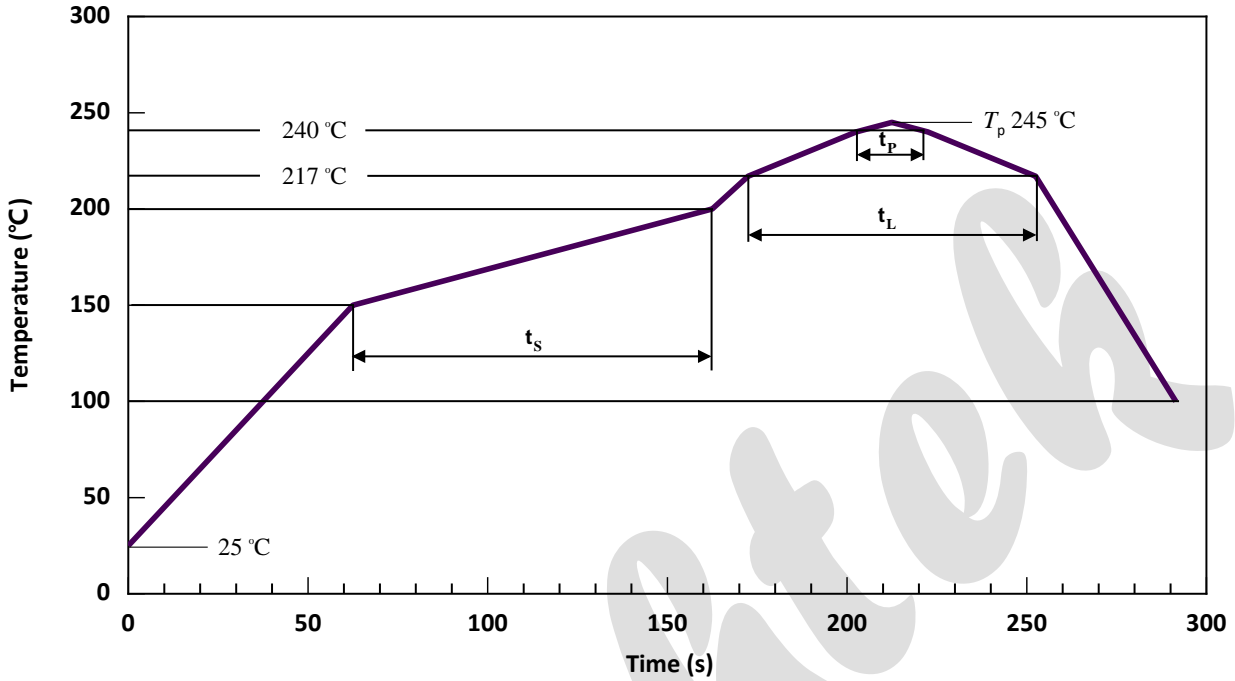
$$I_F = f(t_p); D = \text{Duty cycle}; T_s \text{ max} = 85^\circ\text{C}$$



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## Reflow Soldering Profile

Product complies to MSL Level 1 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{Smin}$ to $T_{Smax}$	$t_s$	60	100	120	s
Ramp-up rate to peak $T_{Smax}$ to $T_P$			2	3	K/s
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_P$		245	260	°C
Time within 5 °C of the specified peak temperature $T_P - 5$ K	$T_P$	10	20	30	s
Ramp-down Rate $T_P$ to 100 °C			3	4	K/s
Time 25 °C to $T_P$				480	s

1. Do not stress the silicone resin while it is exposed to high temperature.
2. The reflow process should not exceed 2 times.





## Disclaimer

1. Brightek reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets Brightek published specification for a period of one year from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
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